EAST Search History ((3))

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L7	11320	((257/49) or (257/52) or (257/55) or (257/56) or (257/56) or (257/57) or (257/58) or (257/59) or (257/62) or (257/63) or (257/201) or (257/200) or (257/201) or (257/213) or (257/288) or (257/390) or (257/403) or (257/406) or (257/410) or (257/411)).CCLS.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 14:32
L8	0	7 and ((alumin\$1um adj titanate) (titanium adj aluminate) ("Al.sub."\$2 near1 "O.sub."\$2 "AlO.sub."\$2 alumin\$1um adj oxide)) near20 ("Ti.sub."\$2 near1 "O.sub."\$2 near1 "TiO.sub."\$2 (titanium adj oxide)) near20 gate and (channel semiconductor) near4 (("Zn.sub."\$2 near1 "SnO.sub."\$2) (("Zn. sub"\$2 near1 "O") near10 ("SnO. sub."\$2)))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 14:47
L9	8	(("6836540") or ("6998656") or ("6940097") or ("7026713")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 14:49
L10	45	randy near1 hoffman.in.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 14:49
[1]	26	randy near1 hoffman.in. and (zinc adj oxide ZnO ("Zn.sub.2" near1 "O")) and (Ti titanium) and (Al alumin\$1um)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 14:51
S1	3	(("5,470,768") or ("5,879,973") or ("6,569,720")).PN.	USPAT; EPO; JPO; IBM_TDB	OR	OFF	2006/05/31 15:33
S2	20	(("20036013261") or ("6561174") or ("20030104659") or ("20030139026") or ("20030180996") or ("20030186489") or ("20030207502") or ("20030218221") or ("20030218222") or ("20030219530") or ("20030224550")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 16:48

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S3	10	(("20036013261") or ("6561174") or ("20030104659") or ("20030139026") or ("20030180996") or ("20030186489") or ("20030218221") or ("20030218222") or ("20030219530") or ("20030224550")).PN.	US-PGPUB; USPAT	OR	OFF	2005/10/01 16:53
S4	1	("20030013261").PN.	US-PGPUB; USPAT	OR	OFF	2005/10/01 16:52
S5	11	S3 S4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 16:53
S6	9	(("4559238") or ("4589026") or ("4887255") or ("5107314") or ("5744864") or ("6255130") or ("6255655") or ("6362499") or ("6391462")).PN. or ((2002/0153587) or (2002/0171085)).CCLS.	US-PGPUB; USPAT	OR	OFF	2005/10/01 16:56
S7	11	(("4559238") or ("4589026") or ("4887255") or ("5107314") or ("5744864") or ("6255130") or ("6255655") or ("6362499") or ("6391462") or ("20020153587") or ("20020171085")).PN.	US-PGPUB; USPAT	OR	OFF	2005/10/01 16:57
S8	0	ep-0040076\$-\$.did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 16:58
S9	0	ep-00040076\$-\$.did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 16:59
S10	82	sasano.in.	EPO	OR	OFF	2005/10/01 17:02
S11	0	sasano.in. and drain and compound	EPO	OR	OFF	2005/10/01 17:01
S12	0	sasano.in. and drain	EPO .	OR	OFF	2005/10/01 17:02
S13	4	sasano.in. and semiconductor	EPO	OR	OFF	2005/10/01 17:02
S14	1	(EP-40076-\$).did.	EPO	OR	OFF	2005/10/01 17:08

<i>;</i>	S15	4	(("5,744,864") or ("20020101557")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/10/01 17:08
	S16	2	(("5,744,864") or ("20020101557")).PN.	US-PGPUB; USPAT	OR	OFF	2005/10/01 17:08
	S17	4	"763353".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:40
,	S18	4	"763353".ap.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:42
,	S19	2	"20040127038".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:51
	S20	5	"2004023432".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:52
,	S21	2	"20040023432".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:53
	S22	4	S19 S21	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:55
	S23	2	jp-2003086808\$-\$.did.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:56
	S24	2	("20030047785").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 11:56

	S25	0	Garcia.in. and ("Zn.sub.2" near1	US-PGPUB;	OR	OFF	2006/05/31 12:44
/	323	J	"Sn" near1 "O.sub.4")	USPAT; EPO; JPO; DERWENT; IBM_TDB	<u> </u>		
	S26	0	("257"/\$7.ccls. "438"/\$7.ccls. "117"/\$7.ccls.) and ("Zn.sub.2" near1 "Sn" near1 "O.sub.4") near10 (semiconductor channel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/31 12:45
	S27	3	("257"/\$7.ccls. "438"/\$7.ccls. "117"/\$7.ccls.) and (zinc adj stannate "Zn.sub.2" near1 "Sn" near1 "O.sub.4") near10 (semiconductor channel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/31 12:48
;	S28	10	(zinc adj stannate "Zn.sub.2" near1 "Sn" near1 "O.sub.4") near10 (semiconductor channel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/31 12:49
,	S29	2	(zinc adj stannate "Zn.sub.2" near1 "Sn" near1 "O.sub.4") near10 (semiconductor channel) and (MOSFET MOS MISFET MESFET JFET NMOS NMOSFET PMOS PMOSFET field adj effect gate transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/31 12:50
	S30	0	(zinc adj stannate "Zn.sub.2" near1 "Sn" near1 "O.sub.4") near10 (semiconductor channel) and (MOSFET MOS MISFET MESFET JFET NMOS NMOSFET PMOS PMOSFET field adj effect gate transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 13:02
<i>†</i>	S31	0	(zinc adj stannate "Zn.sub.2" near1 "Sn" near1 "O.sub.4" cubic adj spinel) near10 (semiconductor channel) and (MOSFET MOS MISFET MESFET JFET NMOS NMOSFET PMOS PMOSFET field adj effect gate transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 13:02
1	S32	0	(zinc adj stannate "Zn.sub.2" near1 "Sn" near1 "O.sub.4" zinc adj spinel) near10 (semiconductor channel) and (MOSFET MOS MISFET MESFET JFET NMOS NMOSFET PMOS PMOSFET field adj effect gate transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 13:10

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	S33	324	transparent near1 (thin adj film adj transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 13:11
<i>;</i>	S34	0	(transparent near1 (thin adj film adj transistor tft) ttft) and ("Zn. sub.2" near1 "Sn" near1 "O.sub. 4")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	-2006/05/31 13:12
<i>;</i>	S35	0	((transparent near1 (thin adj film adj transistor tft)) ttft) and ("Zn. sub.2" near1 "Sn" near1 "O.sub. 4")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/05/31 13:12
	S36	0	alumin\$1um adj titanate near6 gate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/05/31 15:33
,	S37	9707	("AlO.sub."\$4 "TiO.sub."\$4 "Al. sub."\$4 alumin\$1um adj titanate titanium adj aluminate) and gate and (transistor field adj effect MOSFET MOS NMOS PMOS NMOSFET PMOSFET NMISFET PMISFET PMIS TFT thin adj film adj transistor OTFT)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 09:58
	S38	115	(("TiO.sub."\$4 near4 "AlO.sub. "\$4) (alumin\$1um adj titanate) (titanium adj aluminate)) and gate and (transistor field adj effect MOSFET MOS NMOS PMOS NMOSFET PMOSFET NMISFET PMISFET PMIS TFT thin adj film adj transistor OTFT)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 10:00
	S39	79	(("TiO.sub."\$4 near4 "AlO.sub. "\$4) (alumin\$1um adj titanate) (titanium adj aluminate)) and gate and (transistor field adj effect MOSFET MOS NMOS PMOS NMOSFET PMOSFET NMISFET PMISFET PMIS TFT thin adj film adj transistor OTFT) and @ad<"20030726"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 10:03

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S40	0	(("TiO.sub."\$4 near4 "AlO.sub. "\$4) (alumin\$1um adj titanate) (titanium adj aluminate)) near15 gate and (transistor field adj effect MOSFET MOS NMOS PMOS NMOSFET PMOSFET NMISFET PMISFET PMIS TFT thin adj film adj transistor OTFT) and @ad<"20030726"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 10:16
S41	4	"763353".ap.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/01 11:39
S42	706	((alumin\$1um adj oxide) ("Al.sub."\$3 near1 (O "O.sub."\$3)) "AlO.sub."\$3) near8 (titanium adj oxide ("Ti.sub."\$3 near1 (O "O.sub."\$3)) "TiO.sub."\$3) same gate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR ·	ON	2006/06/01 11:52
S43	131	((alumin\$1um adj oxide) ("Al.sub."\$3 near1 (O "O.sub."\$3)) "AlO.sub."\$3) near8 (titanium adj oxide ("Ti.sub."\$3 near1 (O "O.sub."\$3)) "TiO.sub."\$3) near10 gate near10 (dielectric insulati\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 11:53
S44	66	((alumin\$1um adj oxide) ("Al.sub."\$3 near1 (O "O.sub."\$3)) "AlO.sub."\$3) near8 (titanium adj oxide ("Ti.sub."\$3 near1 (O "O.sub."\$3)) "TiO.sub."\$3) near10 gate near10 (dielectric insulati\$2)	USPAT	OR	ON	2006/06/01 11:53
S45	2	"20050253157".pn,	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/01 15:47
S46	140	rf adj sputtering near6 amorphous	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/01 15:47
S47	0	(zno zinc adj oxide) near10 (rf adj sputtering near6 amorphous)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 15:48

<i>)</i>	S48	16	(oxide) near10 (rf adj sputtering near6 amorphous)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 15:50
•	S49	259	(oxide) near10 (sputtering near6 amorphous)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 15:50
	S50	19	(zinc adj oxide zno) near10 (sputtering near6 amorphous)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 15:51
	S51	1	(US-20050017244-\$).did.	US-PGPUB	OR	OFF	2006/06/01 16:10
,	S52	1	S51 and transparent	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 16:10
,	S53	0	dissocation adj constant near5 (zinc adj stannate)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 16:17
	S54	0	dissocation adj constant near5 (("Zn.sub.2" near1 "Sn" near1 "O. sub.4") (zinc adj stannate))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 16:40
	S55	0	(indium-tin-oxide indium adj tin adj oxide ITO) and "20040127038".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:16
	S56	11	drain-to-gate near4 bias	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:24
	S57	1894	drain near2 connecti\$2 near2 gate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:25

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S58	7956	drain near1 connect\$3 near1 gate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:25
S59	571	drain near1 connecti\$3 near1 gate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:33
S60	49	back adj gate and gate-to-drain	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:34
S61	2	back adj gate and gate-to-drain and (tft thin adj film adj transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:35
S62	2	back adj gate and gate-to-drain and (otft tft thin adj film adj transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:35
S63	2	(back adj gate back-gate) and gate-to-drain and (otft tft thin adj film adj transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:36
S64	334	(back adj gate back-gate) and (otft tft thin adj film adj transistor)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 17:36
S65	267	(back adj gate back-gate) and (otft tft thin adj film adj transistor) and circuit	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 18:02
, S66	29	hot adj electron.ti,ab,clm. and gate-to-drain	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 18:05
S67	585	hot adj electron.ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 18:11

S68	40	hot adj electron adj effect.ti.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 18:14
S69	18	hot adj electron adj effect.ti. and gate near5 drain	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/01 18:15
S70	1	(US-20050017244-\$).did.	US-PGPUB	OR	OFF	2006/06/02 08:40
S71	0	S70 and means	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 08:41
S72	1	(US-20050017244-\$).did.	US-PGPUB	OR	OFF	2006/06/02 08:41
S73	0	S70 and "means"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 08:41
S74	524	(thin adj film adj transistor tft).ti, ab,clm. and (indium-tin ITO) near8 source and (indium-tin ITO) near8 drain	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 09:41
S75	54	(thin adj film adj transistor tft).ti, ab,clm. and (indium-tin ITO) near2 source and (indium-tin ITO) near2 drain	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 09:41

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S76	41	(US-20050104508-\$ or US-20040066484-\$ or US-20030185266-\$ or US-20050017244-\$ or US-20030207502-\$ or US-20030224550-\$ or	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	OFF	2006/06/02 10:16
		US-20030219530-\$ or US-20030218222-\$ or US-20030218221-\$ or US-20030186489-\$ or US-20030139026-\$ or US-20030104659-\$ or US-2003013261-\$ or US-20020171085-\$ or US-20020153587-\$ or US-20040127038-\$ or				
		US-20040023432-\$ or US-20030047785-\$).did. or (US-4521698-\$ or US-6569720-\$ or US-6561174-\$ or US-6391462-\$ or US-6362499-\$ or US-5744864-\$ or US-5107314-\$ or US-4887255-\$ or US-4589026-\$ or US-5879973-\$ or US-5470768-\$ or US-6255655-\$ or US-6255130-\$ or US-4559238-\$ or US-6653206-\$ or US-6617609-\$ or US-7017830-\$).did. or (EP-40076-\$).did. or (JP-2003086808-\$).did. or (WO-200217368-\$ or WO-2004034449-\$ or				
S77	О	US-20030047785-\$).did. (("TiO.sub."\$4 near4 "AlO.sub. "\$4) (alumin\$1um adj titanate) (titanium adj aluminate)) near15 gate and (transistor field adj effect MOSFET MOS NMOS PMOS NMOSFET PMOSFET NMISFET PMISFET PMIS TFT thin adj film adj transistor OTFT) and @ad<"20030726" and S76	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 10:17
S78	0	("AlO.sub."\$3 "A.sub.2O.sub.3") near10 ("TiO.sub."\$72 "TiO.sub. 2") near10 ((insulati\$2 dielectric) near2 gate)	US-PGPUB; ' USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 10:25
S79	69580	("Al.sub."\$1 near1 "O.sub."\$1)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 10:26

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S80	0	("Al.sub."\$1 near1 "O.sub."\$1) near20 ("Ti.sub."\$1 near1 "O.sub. "\$1) near20 gate near20 (dielectric insulati\$2) near20 (combination multi-layer\$2 multilayer\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 10:28
S81	0	("Al.sub."\$1 near1 "O.sub."\$1) near20 ("Ti.sub."\$1 near1 "O.sub. "\$1) near20 gate near20 (dielectric insulati\$2)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 10:28
S82	87	(("Al.sub."\$1 near1 "O.sub."\$1) "AlO.sub."\$1) near20 (("Ti.sub."\$1) near1 "O.sub."\$1) "TiO.sub."\$1) near20 gate near20 (dielectric insulati\$2)	US-PGPUB; (USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 10:30
S83	0.	(("Al.sub."\$1 near1 "O.sub."\$1) "AlO.sub."\$1) near20 (("Ti.sub."\$1 near1 "O.sub."\$1) "TiO.sub."\$1) near20 gate near20 (dielectric insulati\$2) near20 mixture	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/06/02 10:30
S84	1	(("Al.sub."\$1 near1 "O.sub."\$1) "AlO.sub."\$1) near20 (("Ti.sub."\$1) near1 "O.sub."\$1) "TiO.sub."\$1) near20 gate near20 (dielectric insulati\$2) near20 mixture	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 10:35
S85	9	(("Al.sub."\$1 near1 "O.sub."\$1) "AlO.sub."\$1) near20 (("Ti.sub."\$1) near1 "O.sub."\$1) "TiO.sub."\$1) near20 gate near20 (dielectric insulati\$2) near20 (combination mixture multi-layer multi adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 10:42
S86	0	(("Al.sub."\$1 near1 "O.sub."\$1) "AlO.sub."\$1) near20 (("Ti.sub."\$1) near1 "O.sub."\$1) "TiO.sub."\$1) near20 gate near20 (dielectric insulati\$2) near20 (combination mixture multi-layer multi adj layer) and (thin adj film adj transistor tft otft)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 10:43
S87	9	(("Al.sub."\$1 near1 "O.sub."\$1) "AlO.sub."\$1) near20 (("Ti.sub."\$1) near1 "O.sub."\$1) "TiO.sub."\$1) near20 gate near20 (dielectric insulati\$2) near20 (combination mixture multi-layer multi adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 10:53

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S88	9	(("Al.sub."\$1 near1 "O.sub."\$1) "AlO.sub."\$1 (alumin\$1um adj titanate) (titanium adj aluminate)) near20 (("Ti.sub."\$1 near1 "O. sub."\$1) "TiO.sub."\$1) near20 gate near20 (dielectric insulati\$2) near20 (combination mixture multi-layer multi adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 10:55
S89	9	(("Al.sub."\$3 near1 "O.sub."\$3) "AlO.sub."\$3 (alumin\$1um adj titanate) (titanium adj aluminate)) near20 (("Ti.sub."\$3 near1 "O. sub."\$3) "TiO.sub."\$3) near20 gate near20 (dielectric insulati\$2) near20 (combination mixture multi-layer multi adj layer)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 12:48
S90	209	(("Al.sub."\$3 near1 "O.sub."\$3) "AlO.sub."\$3) near20 (("Ti.sub."\$3) near1 "O.sub."\$3) "TiO.sub."\$3) near20 barrier	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 12:49
S91	5	(("Al.sub."\$3 near1 "O.sub."\$3) "AlO.sub."\$3) near20 (("Ti.sub."\$3 near1 "O.sub."\$3) "TiO.sub."\$3) near20 barrier near20 gate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 12:52
S92	0	(("Al.sub."\$3 near1 "O.sub."\$3) "AlO.sub."\$3) near20 (cap adj (layer film)) near20 gate near20 (semiconductor channel)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 12:53
S93	3.	((alumin\$1um adj oxide) ("Al.sub."\$3 near1 (O "O.sub."\$3)) "AlO.sub."\$3) near8 (cap adj layer) near20 gate	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 12:59
S94	1839	((alumin\$1um adj oxide) ("Al.sub."\$3 near1 (O "O.sub."\$3)) "AIO.sub."\$3) near4 barrier	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 12:59
S95	45	((alumin\$1um adj oxide) ("Al.sub."\$3 near1 (O "O.sub."\$3)) "AlO.sub."\$3) near4 barrier near4 (Ti titanium)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/06/02 13:03

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